

Declaration of Chipset Change

We, HMD Global Oy, hereby declare that the product TA-1339:

Model	Sim Card	SW Version	HW Version	Band
TA-1339	Dual Sim	000T_1_111	V01B	GSM:850/900/1800/1900 WCDMA: B1/2/4/5/8 LTE:B1/2/3/4/5/7/8/12/17/28/66

Will implement the following chipset change:

METHOD OF IDENTIFICATION: the chip can be distinguished from marking.



Description of Change:

Wafer fabrication process changed from 28nm to 22nm.

IMPACT OF CHANGE:

- HW: Hardware reference design unchanged, chip PIN to PIN, Datasheet updated.
 1. It is just change the BB chipset, from SC9863A to SC9863A1, the CPU is minor change which Wafer Fab Process changed from 28nm to 22nm.
 2. SC9863A1 is main BB chipset, not integrates RF transmitters, memory.
 3. From Unisoc side, they are the same series chipset and also P2P completely compatible, did not update the block diagrams to distinguish the two chipsets.
 4. They use the same PMU SC2721.
 5. They use the same RF Transceiver SR3595D.
- SW:
 1. Android A10/11 provides common Patch upgrade, SC9863A1 and SC9863A software engineering;
 2. Android A12 provides a baseline version (compatible with SC9863A1 and SC9863A);
 3. Update the WCN configuration document.

TA-1339 will not have any other changes.



The Home of Nokia Phones

HMD Global Oy
Bertel Jungin aukio 9
02600 Espoo, Finland

Tel +358 86 4213499
Fax +358 45 2133756

If you should have any question(s) regarding this declaration, please don't hesitate to contact us. Thank you!

A square image showing a handwritten signature in black ink. The signature is stylized and appears to read 'Serafat'.

Signature: _____.

Name: Reza Serafat

Position: GM, Global Quality & Customer Compliance

E-mail: reza.serafat@hmdglobal.com

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